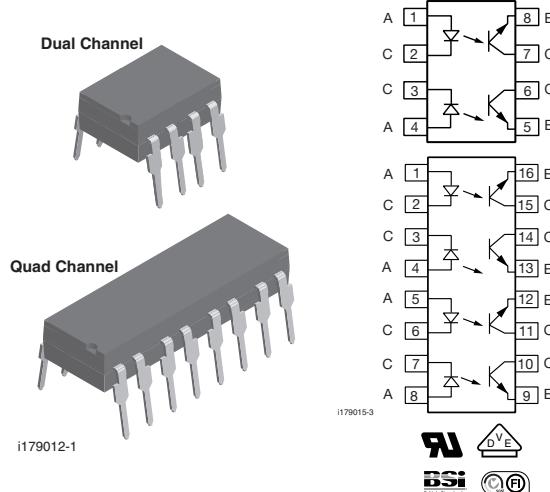


Optocoupler, Phototransistor Output (Dual, Quad Channel)



DESCRIPTION

The ILD1, ILD2, ILD5, ILQ1, ILQ2, ILQ5 are optically coupled isolated pairs employing GaAs infrared LEDs and silicon NPN phototransistor. Signal information, including a DC level, can be transmitted by the drive while maintaining a high degree of electrical isolation between input and output. The ILD1, ILD2, ILD5, ILQ1, ILQ2, ILQ5 are especially designed for driving medium-speed logic and can be used to eliminate troublesome ground loop and noise problems. Also these couplers can be used to replace relays and transformers in many digital interface applications such as CTR modulation.

The ILD1, ILD2, ILD5 has two isolated channels in a single DIP package and the ILQ1, ILQ2, ILQ5 has four isolated channels per package.

FEATURES

- Current transfer ratio at $I_F = 10 \text{ mA}$
- Isolation test voltage, $5300 \text{ V}_{\text{RMS}}$
- Compliant to RoHS Directive 2002/95/EC and in accordance to WEEE 2002/96/EC



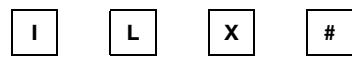
RoHS
COMPLIANT

AGENCY APPROVALS

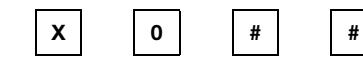
- UL1577, file no. E52744 system code H or J, double protection
- CSA 93751
- BSI IEC 60950; IEC 60065
- DIN EN 60747-5-2 (VDE 0884) available with option 1
- FIMKO



ORDERING INFORMATION



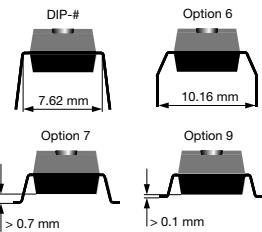
PART NUMBER



PACKAGE OPTION



TAPE AND REEL



AGENCY CERTIFIED/PACKAGE	CTR (%)		
UL, CUL, BSI, FIMKO	20	50	100
DIP-16	ILQ1	ILQ5	ILQ2
DIP-16, 400 mil, option 6	ILQ1-X006	-	ILQ2-X006
SMD-16, option 7	ILQ1-X007	-	ILQ2-X007T ⁽¹⁾
SMD-16, option 9	ILQ1-X009	ILQ5-X009T ⁽¹⁾	ILQ2-X009T ⁽¹⁾
DIP-8	ILD1	ILD5	ILD2
DIP-8, 400 mil, option 6	-	-	ILD2-X006
SMD-8, option 7	ILD1-X007T ⁽¹⁾	-	ILD2-X007T ⁽¹⁾
SMD-8, option 9	ILD1-X009T ⁽¹⁾	ILD5-X009T ⁽¹⁾	ILD2-X009T ⁽¹⁾

ILD1, ILD2, ILD5, ILQ1, ILQ2, ILQ5



Vishay Semiconductors Optocoupler, Phototransistor Output
(Dual, Quad Channel)

AGENCY CERTIFIED/PACKAGE	CTR (%)		
	20	50	100
VDE, UL, CUL, BSI,	-	-	-
DIP-16	-	-	ILQ2-X001
DIP-16, 400 mil, option 6	-	-	ILQ2-X016
SMD-16, option 7	-	-	ILQ2-X017T ⁽¹⁾
DIP-8	ILD1-X001	ILD5-X001	ILD2-X001
DIP-8, 400 mil, option 6	-	-	ILD2-X016
SMD-8, option 7	-	-	ILD2-X017
SMD-8, option 9	ILD1-X019T	-	-

Note

⁽¹⁾ Also available in tubes; do not put T on end.

ABSOLUTE MAXIMUM RATINGS ⁽¹⁾ ($T_{amb} = 25^{\circ}\text{C}$, unless otherwise specified)

PARAMETER	TEST CONDITION	PART	SYMBOL	VALUE	UNIT
INPUT					
Reverse voltage			V_R	6	V
Forward current			I_F	60	mA
Surge current			I_{FSM}	2.5	A
Power dissipation			P_{diss}	100	mW
Derate linearly from 25°C				1.3	mW/ $^{\circ}\text{C}$
OUTPUT					
Collector emitter reverse voltage		ILD1	V_{CEO}	50	V
		ILQ1	V_{CEO}	50	V
		ILD2	V_{CEO}	70	V
		ILQ2	V_{CEO}	70	V
		ILD5	V_{CEO}	70	V
		ILQ5	V_{CEO}	70	V
Collector current			I_C	50	mA
	$t < 1 \text{ ms}$		I_C	400	mA
Power dissipation			P_{diss}	200	mW
Derate linearly from 25°C				2.6	mW/ $^{\circ}\text{C}$
<b b="" coupler<="">					
Isolation test voltage between emitter and detector			V_{ISO}	5300	V_{RMS}
Creepage distance				≥ 7	mm
Clearance distance				≥ 7	mm
Isolation resistance	$V_{IO} = 500 \text{ V}, T_{amb} = 25^{\circ}\text{C}$		R_{IO}	10^{12}	Ω
	$V_{IO} = 500 \text{ V}, T_{amb} = 100^{\circ}\text{C}$		R_{IO}	10^{11}	
Package power dissipation			P_{tot}	250	mW
Derate linearly from 25°C				3.3	mW/ $^{\circ}\text{C}$
Storage temperature			T_{stg}	- 40 to + 150	$^{\circ}\text{C}$
Operating temperature			T_{amb}	- 40 to + 100	$^{\circ}\text{C}$
Junction temperature			T_j	100	$^{\circ}\text{C}$
Soldering temperature ⁽²⁾	2 mm from case bottom		T_{sld}	260	$^{\circ}\text{C}$

Notes

- ⁽¹⁾ Stresses in excess of the absolute maximum ratings can cause permanent damage to the device. Functional operation of the device is not implied at these or any other conditions in excess of those given in the operational sections of this document. Exposure to absolute maximum ratings for extended periods of the time can adversely affect reliability.
- ⁽²⁾ Refer to reflow profile for soldering conditions for surface mounted devices (SMD). Refer to wave profile for soldering conditions for through hole devices (DIP).



ILD1, ILD2, ILD5, ILQ1, ILQ2, ILQ5

Optocoupler, Phototransistor Output Vishay Semiconductors
(Dual, Quad Channel)

ELECTRICAL CHARACTERISTICS ($T_{amb} = 25^\circ C$, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
INPUT						
Forward voltage	$I_F = 60 \text{ mA}$	V_F		1.25	1.65	V
Reverse current	$V_R = 6 \text{ V}$	I_R		0.01	10	μA
Capacitance	$V_R = 0 \text{ V}, f = 1 \text{ MHz}$	C_O		25		pF
Thermal resistance, junction to lead		R_{thJL}		750		K/W
OUTPUT						
Collector emitter capacitance	$V_{CE} = 5 \text{ V}, f = 1 \text{ MHz}$	C_{CE}		6.8		pF
Collector emitter leakage current	$V_{VCE} = 10 \text{ V}$	I_{CEO}		5	50	nA
Saturation voltage, collector emitter	$I_C = 1 \text{ mA}, I_B = 20 \mu\text{A}$	V_{CESAT}		0.25	0.4	V
DC forward current gain	$V_{CE} = 10 \text{ V}, I_B = 20 \mu\text{A}$	h_{FE}	200	650	1800	
DC forward current gain saturated	$V_{CE} = 0.4 \text{ V}, I_B = 20 \mu\text{A}$	h_{FEsat}	120	400	600	
Thermal resistance, junction to lead		R_{thJL}		500		K/W
<b b="" coupler<="">						
Capacitance (input to output)	$V_{IO} = 0 \text{ V}, f = 1 \text{ MHz}$	C_{IO}		0.8		pF

Note

- Minimum and maximum values are testing requirements. Typical values are characteristics of the device and are the result of engineering evaluation. Typical values are for information only and are not part of the testing requirements.

CURRENT TRANSFER RATIO						
PARAMETER	TEST CONDITION	PART	SYMBOL	MIN.	TYP.	MAX.
I_C/I_F (collector emitter saturated)	$I_F = 10 \text{ mA}, V_{CE} = 0.4 \text{ V}$	ILD1	CTR_{CEsat}		75	%
		ILQ1	CTR_{CEsat}		75	%
		ILD2	CTR_{CEsat}		170	%
		ILQ2	CTR_{CEsat}		170	%
		ILD5	CTR_{CEsat}		100	%
		ILQ5	CTR_{CEsat}		100	%
	$I_F = 10 \text{ mA}, V_{CE} = 10 \text{ V}$	ILD1	CTR_{CE}	20	80	300
		ILQ1	CTR_{CE}	20	80	300
		ILD2	CTR_{CE}	100	200	500
		ILQ2	CTR_{CE}	100	200	500
		ILD5	CTR_{CE}	50	130	400
		ILQ5	CTR_{CE}	50	130	400

ILD1, ILD2, ILD5, ILQ1, ILQ2, ILQ5



Vishay Semiconductors Optocoupler, Phototransistor Output
(Dual, Quad Channel)

SWITCHING CHARACTERISTICS							
PARAMETER	TEST CONDITION	PART	SYMBOL	MIN.	TYP.	MAX.	UNIT
NON-SATURATED							
Current	$V_{CE} = 5 \text{ V}$, $R_L = 75 \Omega$, 50 % of V_{PP}	ILD1	I_F		20		mA
		ILQ1	I_F		20		mA
		ILD2	I_F		5		mA
		ILQ2	I_F		5		mA
		ILD5	I_F		10		mA
		ILQ5	I_F		10		mA
Delay	$V_{CE} = 5 \text{ V}$, $R_L = 75 \Omega$, 50 % of V_{PP}	ILD1	t_D		0.8		μs
		ILQ1	t_D		0.8		μs
		ILD2	t_D		1.7		μs
		ILQ2	t_D		1.7		μs
		ILD5	t_D		1.7		μs
		ILQ5	t_D		1.7		μs
Rise time	$V_{CE} = 5 \text{ V}$, $R_L = 75 \Omega$, 50 % of V_{PP}	ILD1	t_r		1.9		μs
		ILQ1	t_r		1.9		μs
		ILD2	t_r		2.6		μs
		ILQ2	t_r		2.6		μs
		ILD5	t_r		2.6		μs
		ILQ5	t_r		2.6		μs
Storage	$V_{CE} = 5 \text{ V}$, $R_L = 75 \Omega$, 50 % of V_{PP}	ILD1	t_s		0.2		μs
		ILQ1	t_s		0.2		μs
		ILD2	t_s		0.4		μs
		ILQ2	t_s		0.4		μs
		ILD5	t_s		0.4		μs
		ILQ5	t_s		0.4		μs
NON-SATURATED							
Fall time	$V_{CE} = 5 \text{ V}$, $R_L = 75 \Omega$, 50 % of V_{PP}	ILD1	t_f		1.4		μs
		ILQ1	t_f		1.4		μs
		ILD2	t_f		2.2		μs
		ILQ2	t_f		2.2		μs
		ILD5	t_f		2.2		μs
		ILQ5	t_f		2.2		μs
Propagation H to L	$V_{CE} = 5 \text{ V}$, $R_L = 75 \Omega$, 50 % of V_{PP}	ILD1	t_{PHL}		0.7		μs
		ILQ1	t_{PHL}		0.7		μs
		ILD2	t_{PHL}		1.2		μs
		ILQ2	t_{PHL}		1.2		μs
		ILD5	t_{PHL}		1.1		μs
		ILQ5	t_{PHL}		1.1		μs
Propagation L to H	$V_{CE} = 5 \text{ V}$, $R_L = 75 \Omega$, 50 % of V_{PP}	ILD1	t_{PLH}		1.4		μs
		ILQ1	t_{PLH}		1.4		μs
		ILD2	t_{PLH}		2.3		μs
		ILQ2	t_{PLH}		2.3		μs
		ILD5	t_{PLH}		2.5		μs
		ILQ5	t_{PLH}		2.5		μs

SWITCHING CHARACTERISTICS							
PARAMETER	TEST CONDITION	PART	SYMBOL	MIN.	TYP.	MAX.	UNIT
SATURATED							
Current	$V_{CE} = 0.4 \text{ V}$, $R_L = 1 \text{ k}\Omega$, $V_{CC} = 5 \text{ V}$, $V_{TH} = 1.5 \text{ V}$	ILD1	I_F		20		mA
		ILQ1	I_F		20		mA
		ILD2	I_F		5		mA
		ILQ2	I_F		5		mA
		ILD5	I_F		10		mA
		ILQ5	I_F		10		mA
Delay	$V_{CE} = 0.4 \text{ V}$, $R_L = 1 \text{ k}\Omega$, $V_{CC} = 5 \text{ V}$, $V_{TH} = 1.5 \text{ V}$	ILD1	t_D		0.8		μs
		ILQ1	t_D		0.8		μs
		ILD2	t_D		1		μs
		ILQ2	t_D		1		μs
		ILD5	t_D		1.7		μs
		ILQ5	t_D		1.7		μs
Rise time	$V_{CE} = 0.4 \text{ V}$, $R_L = 1 \text{ k}\Omega$, $V_{CC} = 5 \text{ V}$, $V_{TH} = 1.5 \text{ V}$	ILD1	t_r		1.2		μs
		ILQ1	t_r		1.2		μs
		ILD2	t_r		2		μs
		ILQ2	t_r		2		μs
		ILD5	t_r		7		μs
		ILQ5	t_r		7		μs
Storage	$V_{CE} = 0.4 \text{ V}$, $R_L = 1 \text{ k}\Omega$, $V_{CC} = 5 \text{ V}$, $V_{TH} = 1.5 \text{ V}$	ILD1	t_s		7.4		μs
		ILQ1	t_s		7.4		μs
		ILD2	t_s		5.4		μs
		ILQ2	t_s		5.4		μs
		ILD5	t_s		4.6		μs
		ILQ5	t_s		4.6		μs
SATURATED							
Fall time	$V_{CE} = 0.4 \text{ V}$, $R_L = 1 \text{ k}\Omega$, $V_{CC} = 5 \text{ V}$, $V_{TH} = 1.5 \text{ V}$	ILD1	t_f		7.6		μs
		ILQ1	t_f		7.6		μs
		ILD2	t_f		13.5		μs
		ILQ2	t_f		13.5		μs
		ILD5	t_f		20		μs
		ILQ5	t_f		20		μs
Propagation H to L	$V_{CE} = 0.4 \text{ V}$, $R_L = 1 \text{ k}\Omega$, $V_{CC} = 5 \text{ V}$, $V_{TH} = 1.5 \text{ V}$	ILD1	t_{PHL}		1.6		μs
		ILQ1	t_{PHL}		1.6		μs
		ILD2	t_{PHL}		5.4		μs
		ILQ2	t_{PHL}		5.4		μs
		ILD5	t_{PHL}		2.6		μs
		ILQ5	t_{PHL}		2.6		μs
Propagation L to H	$V_{CE} = 0.4 \text{ V}$, $R_L = 1 \text{ k}\Omega$, $V_{CC} = 5 \text{ V}$, $V_{TH} = 1.5 \text{ V}$	ILD1	t_{PLH}		8.6		μs
		ILQ1	t_{PLH}		8.6		μs
		ILD2	t_{PLH}		7.4		μs
		ILQ2	t_{PLH}		7.4		μs
		ILD5	t_{PLH}		7.2		μs
		ILQ5	t_{PLH}		7.2		μs

ILD1, ILD2, ILD5, ILQ1, ILQ2, ILQ5



Vishay Semiconductors Optocoupler, Phototransistor Output
(Dual, Quad Channel)

COMMON MODE TRANSIENT IMMUNITY

PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Common mode rejection, output high	$V_{CM} = 50 \text{ V}_{P-P}$, $R_L = 1 \text{ k}\Omega$, $I_F = 0 \text{ mA}$	CM_H		5000		$\text{V}/\mu\text{s}$
Common mode rejection, output low	$V_{CM} = 50 \text{ V}_{P-P}$, $R_L = 1 \text{ k}\Omega$, $I_F = 10 \text{ mA}$	CM_L		5000		$\text{V}/\mu\text{s}$
Common mode coupling capacitance		C_{CM}		0.01		pF

TYPICAL CHARACTERISTICS ($T_{amb} = 25^\circ\text{C}$, unless otherwise specified)

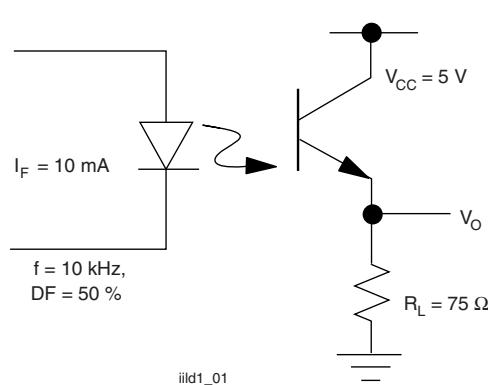


Fig. 1 - Non-Saturated Switching Schematic

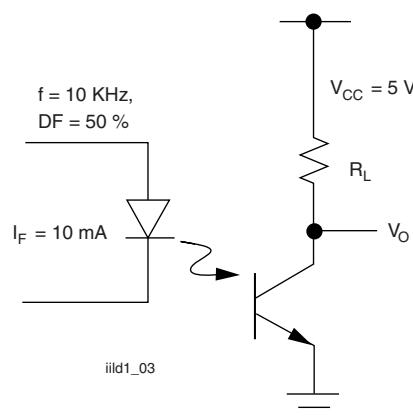


Fig. 3 - Saturated Switching Schematic

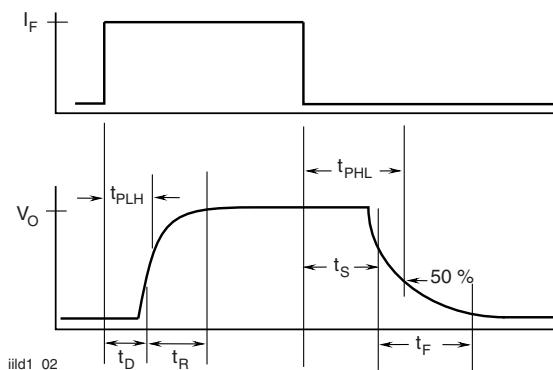


Fig. 2 - Non-Saturated Switching Timing

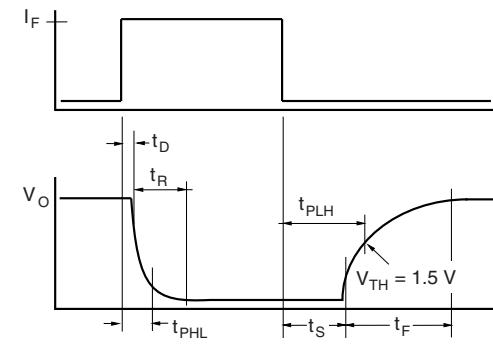


Fig. 4 - Saturated Switching Timing

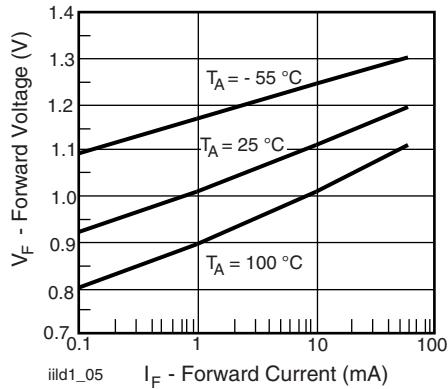


Fig. 5 - Normalized Non-Saturated and Saturated CTR vs.
LED Current

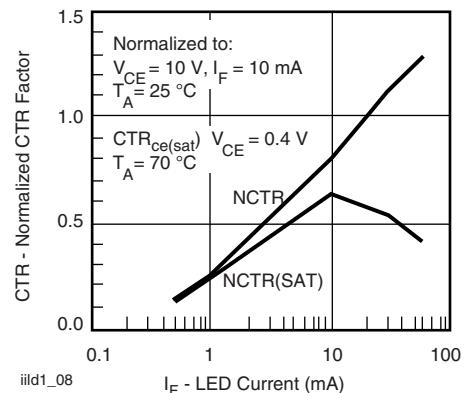


Fig. 8 - Normalized Non-Saturated and Saturated CTR vs.
LED Current

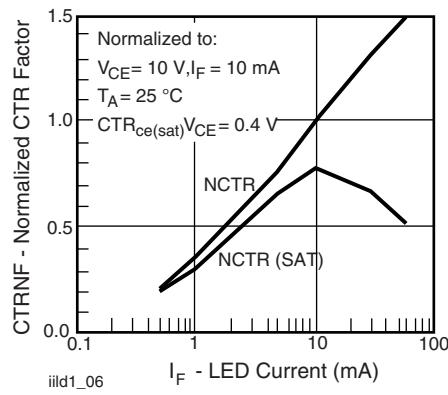


Fig. 6 - Normalized Non-Saturated and Saturated CTR vs.
LED Current

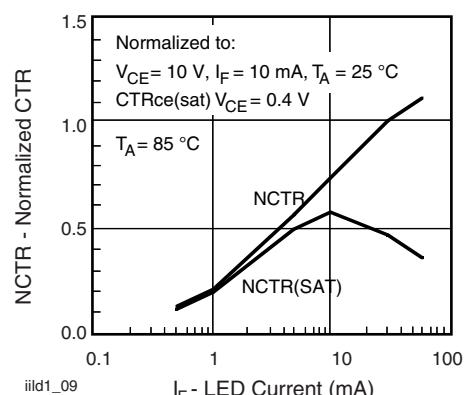


Fig. 9 - Normalized Non-Saturated and Saturated CTR vs.
LED Current

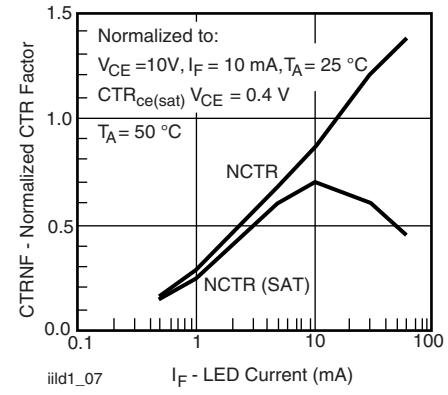


Fig. 7 - Normalized Non-Saturated and Saturated CTR vs.
LED Current

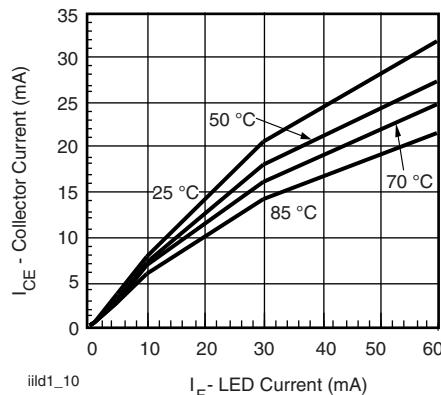


Fig. 10 - Collector Emitter Current vs. Temperature and LED Current

ILD1, ILD2, ILD5, ILQ1, ILQ2, ILQ5



Vishay Semiconductors Optocoupler, Phototransistor Output
(Dual, Quad Channel)

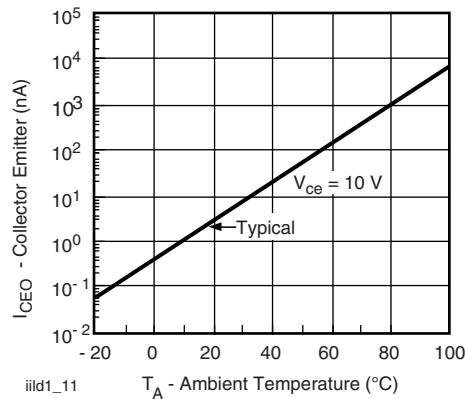


Fig. 11 - Collector Emitter Leakage Current vs. Temperature

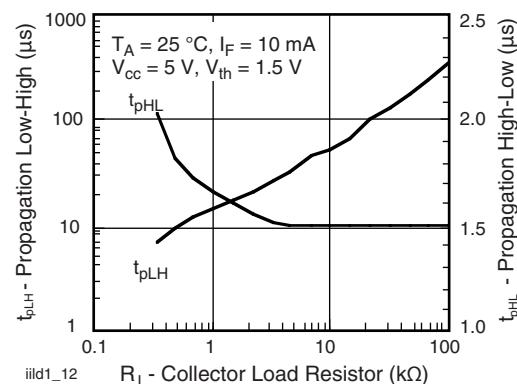
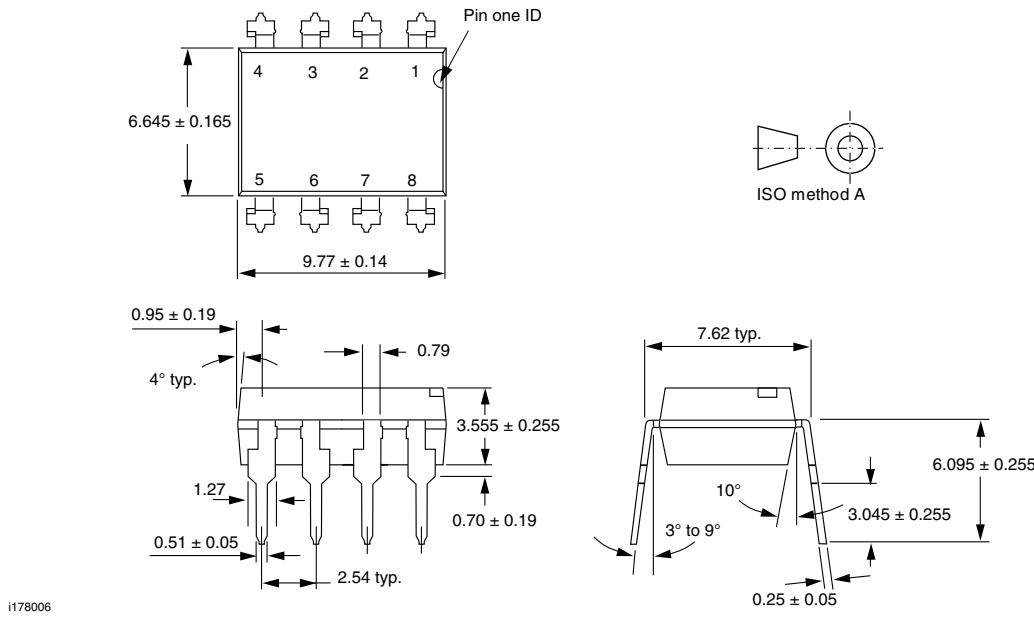
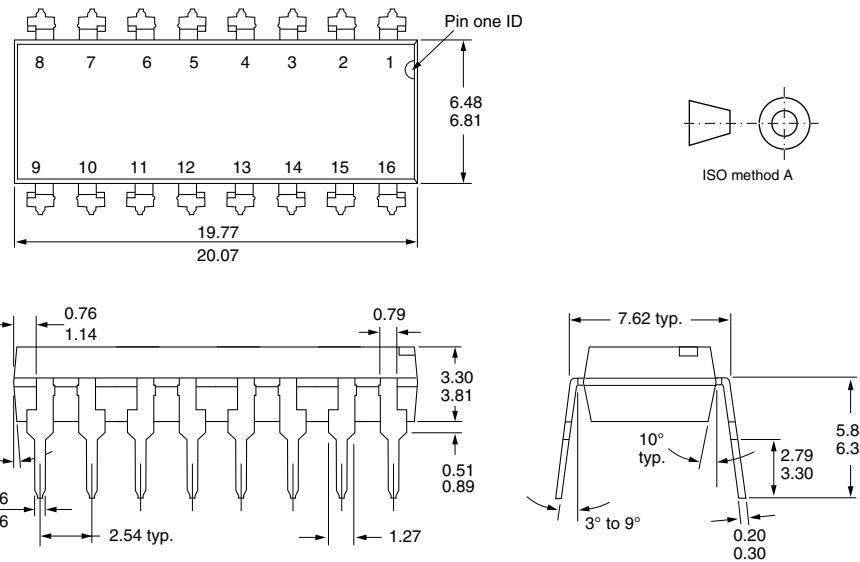


Fig. 12 - Propagation Delay vs. Collector Load Resistor

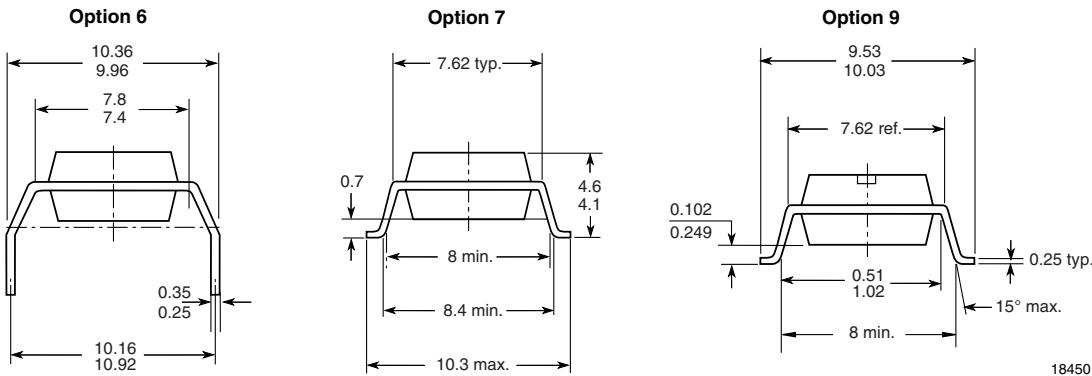
PACKAGE DIMENSIONS in millimeters



PACKAGE DIMENSIONS in millimeters



i178007





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